

Trench gate field-stop IGBT, H series 600 V, 15 A high speed

Datasheet - production data

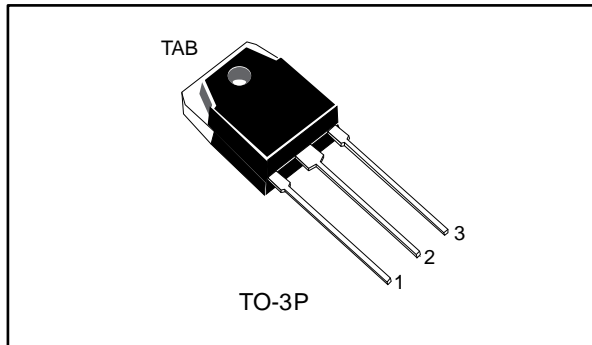
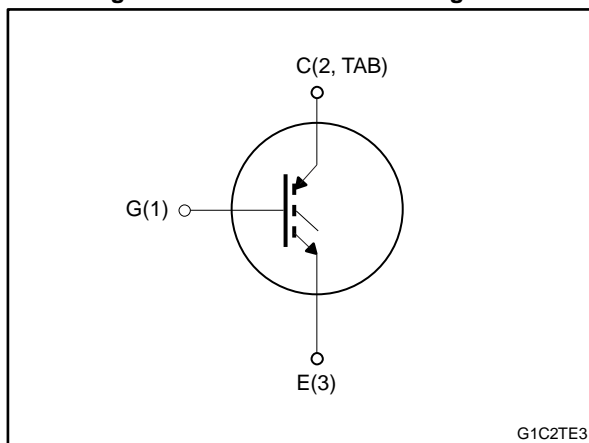


Figure 1: Internal schematic diagram



Features

- High speed switching
- Tight parameter distribution
- Safe paralleling
- Low thermal resistance
- Short-circuit rated

Applications

- Motor control
- UPS
- PFC

Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the H series of IGBTs, which represents an optimum compromise between conduction and switching losses to maximize the efficiency of high switching frequency converters. Furthermore, a slightly positive $V_{CE(sat)}$ temperature coefficient and very tight parameter distribution result in safer paralleling operation.

Table 1: Device summary

| Order code | Marking | Package | Packing |
|-------------|---------|---------|---------|
| STGWT15H60F | G15H60F | TO-3P | Tube |

Contents

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1 Electrical ratings

Table 2: Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|----------------|--|------------|------|
| V_{CES} | Collector-emitter voltage ($V_{GE} = 0$ V) | 600 | V |
| I_C | Continuous collector current at $T_C = 25$ °C | 30 | A |
| | Continuous collector current at $T_C = 100$ °C | 15 | |
| $I_{CP}^{(1)}$ | Pulsed collector current | 60 | A |
| V_{GE} | Gate-emitter voltage | ± 20 | V |
| P_{TOT} | Total dissipation at $T_C = 25$ °C | 115 | W |
| T_{STG} | Storage temperature range | -55 to 150 | °C |
| T_J | Operating junction temperature range | -55 to 175 | °C |

Notes:

⁽¹⁾Pulse width is limited by maximum junction temperature.

Table 3: Thermal data

| Symbol | Parameter | Value | Unit |
|------------|-------------------------------------|-------|------|
| R_{thJC} | Thermal resistance junction-case | 1.3 | °C/W |
| R_{thJA} | Thermal resistance junction-ambient | 50 | °C/W |

2 Electrical characteristics

$T_J = 25\text{ °C}$ unless otherwise specified

Table 4: Static characteristics

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|---------------|--------------------------------------|---|------|------|-----------|---------------|
| $V_{(BR)CES}$ | Collector-emitter breakdown voltage | $V_{GE} = 0\text{ V}$, $I_C = 2\text{ mA}$ | 600 | | | V |
| $V_{CE(sat)}$ | Collector-emitter saturation voltage | $V_{GE} = 15\text{ V}$, $I_C = 15\text{ A}$ | | 1.6 | 2 | V |
| | | $V_{GE} = 15\text{ V}$, $I_C = 15\text{ A}$, $T_J = 125\text{ °C}$ | | 1.7 | | |
| | | $V_{GE} = 15\text{ V}$, $I_C = 15\text{ A}$, $T_J = 175\text{ °C}$ | | 1.8 | | |
| $V_{GE(th)}$ | Gate threshold voltage | $V_{CE} = V_{GE}$, $I_C = 1\text{ mA}$ | 5 | 6 | 7 | V |
| I_{CES} | Collector cut-off current | $V_{GE} = 0\text{ V}$, $V_{CE} = 600\text{ V}$ | | | 25 | μA |
| I_{GES} | Gate-emitter leakage current | $V_{CE} = 0\text{ V}$, $V_{GE} = \pm 20\text{ V}$ | | | ± 250 | nA |

Table 5: Dynamic characteristics

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------|------------------------------|---|------|------|------|------|
| C_{ies} | Input capacitance | $V_{CE} = 25\text{ V}$, $f = 1\text{ MHz}$, $V_{GE} = 0\text{ V}$ | - | 1952 | - | pF |
| C_{oes} | Output capacitance | | - | 78 | - | pF |
| C_{res} | Reverse transfer capacitance | | - | 45 | - | pF |
| Q_g | Total gate charge | $V_{CC} = 480\text{ V}$, $I_C = 15\text{ A}$, $V_{GE} = 0\text{ to }15\text{ V}$ (see Figure 24: "Gate charge test circuit") | - | 81 | - | nC |
| Q_{ge} | Gate-emitter charge | | - | 8 | - | nC |
| Q_{gc} | Gate-collector charge | | - | 42 | - | nC |

Table 6: Switching characteristics (inductive load)

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|----------------|------------------------------|--|------|------|------|------------|
| $t_{d(on)}$ | Turn-on delay time | $V_{CE} = 400\text{ V}$, $I_C = 15\text{ A}$, $V_{GE} = 15\text{ V}$, $R_G = 10\ \Omega$ | | 24.5 | - | ns |
| t_r | Current rise time | | | 8.2 | - | ns |
| $(di/dt)_{on}$ | Turn-on current slope | | | 1470 | - | A/ μ s |
| $t_{d(on)}$ | Turn-on delay time | $V_{CE} = 400\text{ V}$, $I_C = 15\text{ A}$, $V_{GE} = 15\text{ V}$, $R_G = 10\ \Omega$, $T_J = 175\text{ }^\circ\text{C}$ (see Figure 23: "Test circuit for inductive load switching") | | 25 | - | ns |
| t_r | Current rise time | | | 9 | - | ns |
| $(di/dt)_{on}$ | Turn-on current slope | | | 1370 | - | A/ μ s |
| $t_{r(Voff)}$ | Off voltage rise time | $V_{CE} = 400\text{ V}$, $I_C = 15\text{ A}$, $V_{GE} = 15\text{ V}$, $R_G = 10\ \Omega$ | | 18 | - | ns |
| $t_{d(off)}$ | Turn-off delay time | | | 118 | - | ns |
| t_f | Current fall time | | | 69 | - | ns |
| $t_{r(Voff)}$ | Off voltage rise time | $V_{CE} = 400\text{ V}$, $I_C = 15\text{ A}$, $V_{GE} = 15\text{ V}$, $R_G = 10\ \Omega$, $T_J = 175\text{ }^\circ\text{C}$ (see Figure 23: "Test circuit for inductive load switching") | | 27 | - | ns |
| $t_{d(off)}$ | Turn-off delay time | | | 124 | - | ns |
| t_f | Current fall time | | | 101 | - | ns |
| t_{sc} | Short-circuit withstand time | $V_{CC} \leq 360\text{ V}$, $V_{GE} = 15\text{ V}$, $R_G = 10\ \Omega$ | 3 | 5 | - | μ s |

Table 7: Switching energy (inductive load)

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit | |
|-----------------|---------------------------|---|------|------|------|---------|---------|
| $E_{on}^{(1)}$ | Turn-on switching energy | $V_{CE} = 400\text{ V}$, $I_C = 15\text{ A}$, $R_G = 10\ \Omega$, $V_{GE} = 15\text{ V}$ | - | 136 | - | μ J | |
| $E_{off}^{(2)}$ | Turn-off switching energy | | | - | 207 | - | μ J |
| E_{ts} | Total switching energy | | | - | 343 | - | μ J |
| $E_{on}^{(1)}$ | Turn-on switching energy | $V_{CE} = 400\text{ V}$, $I_C = 15\text{ A}$, $R_G = 10\ \Omega$, $V_{GE} = 15\text{ V}$, $T_J = 175\text{ }^\circ\text{C}$ | - | 224 | - | μ J | |
| $E_{off}^{(2)}$ | Turn-off switching energy | | | - | 329 | - | μ J |
| E_{ts} | Total switching energy | | | - | 553 | - | μ J |

Notes:

(1) Including the reverse recovery of the external diode. The diode is the same of the co-packed STGP15H60DF.

(2) Including the tail of the collector current.

2.1 Electrical characteristics (curves)

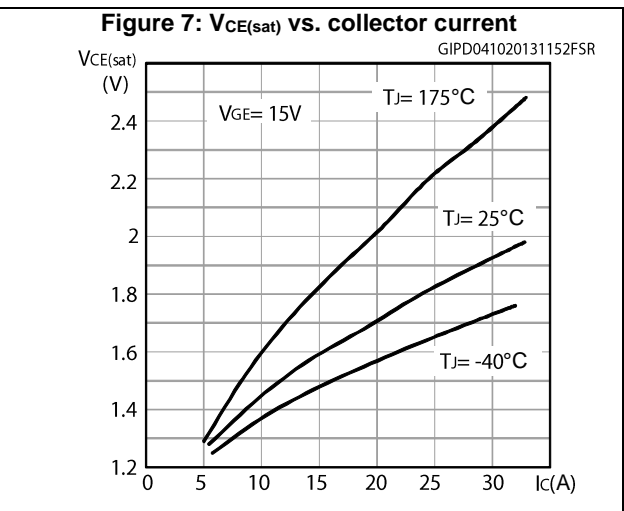
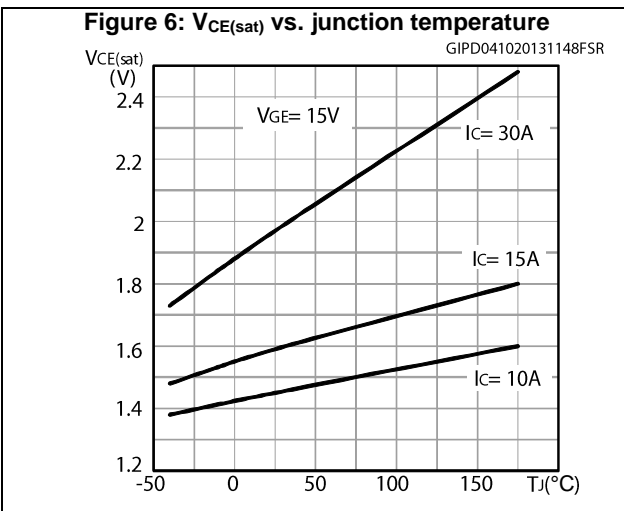
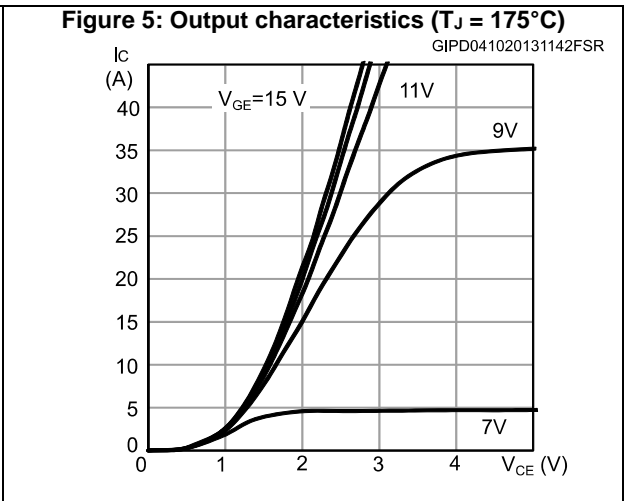
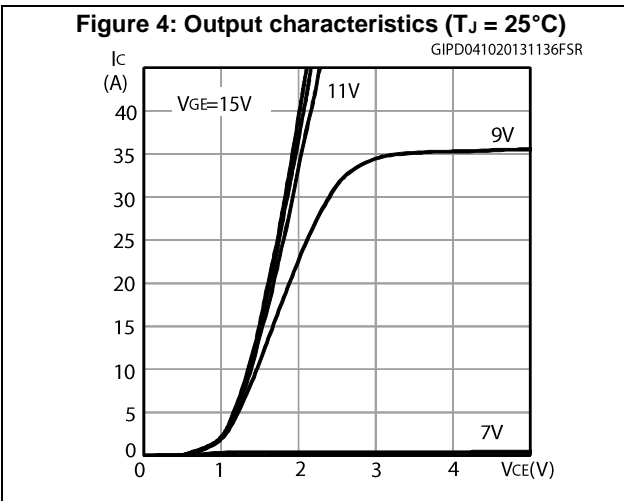
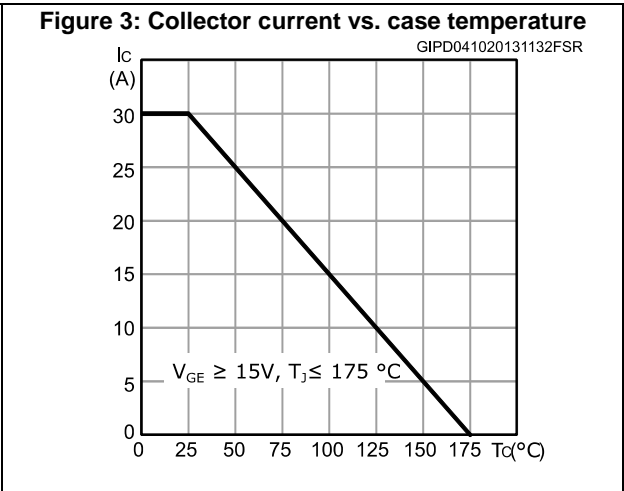
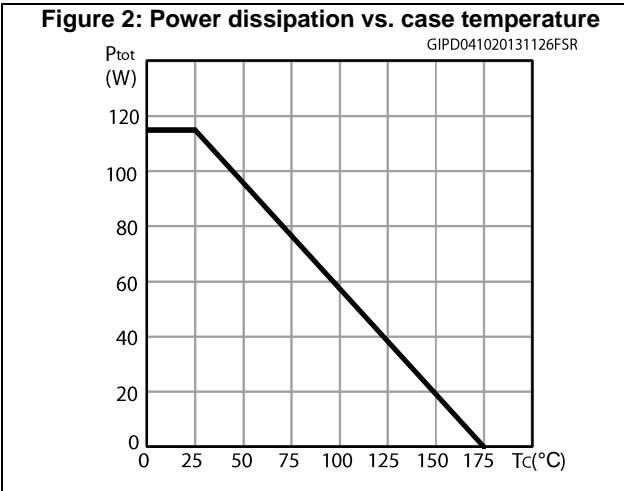


Figure 8: Collector current vs. switching frequency

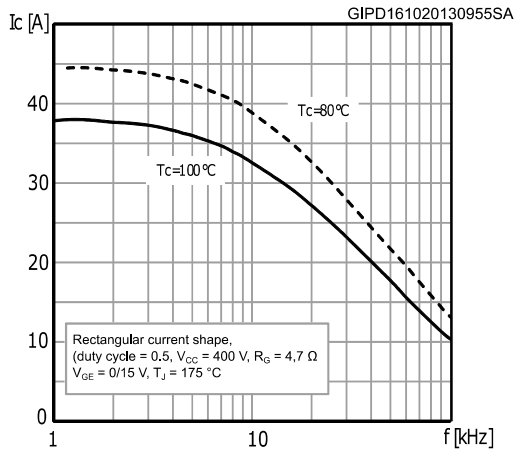


Figure 9: Forward bias safe operating area

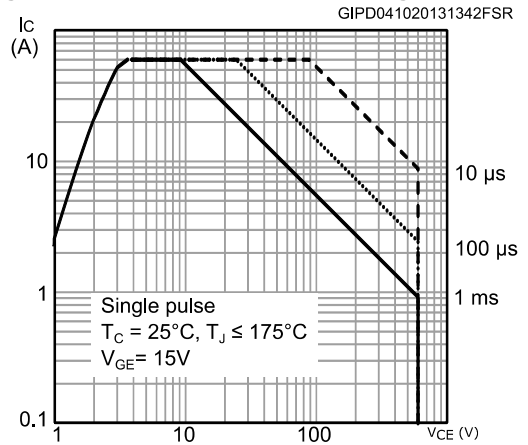


Figure 10: Transfer characteristics

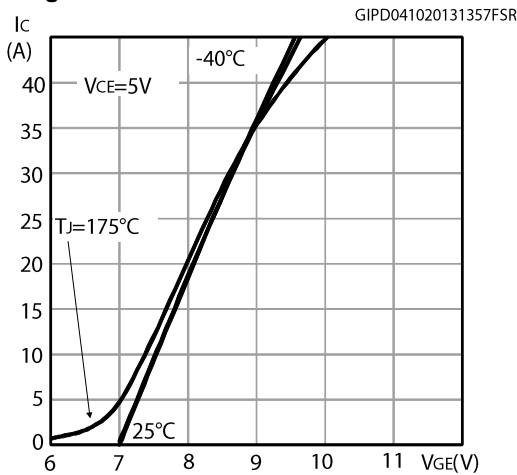


Figure 11: Normalized Vge(th) vs junction temperature

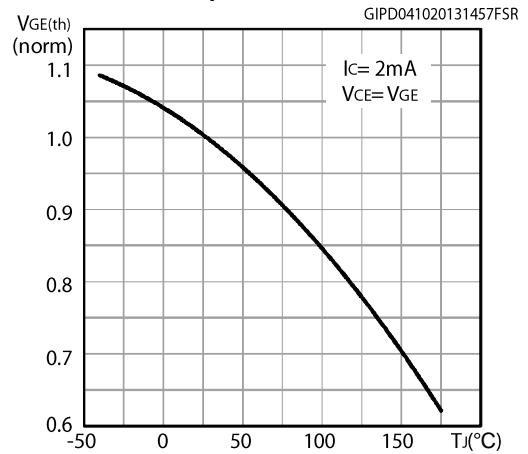


Figure 12: Normalized V(BR)CES vs. junction temperature

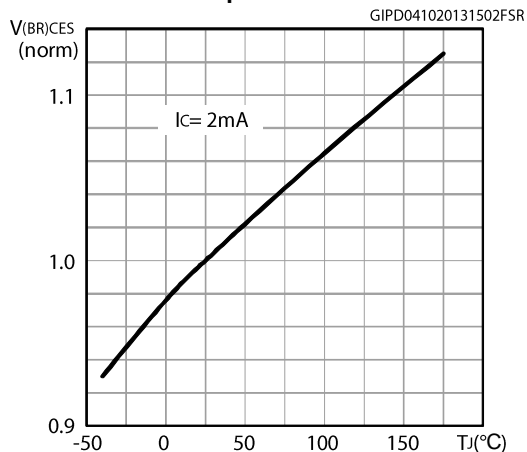
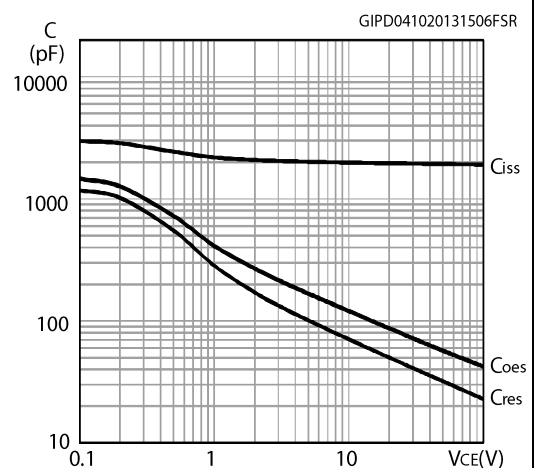
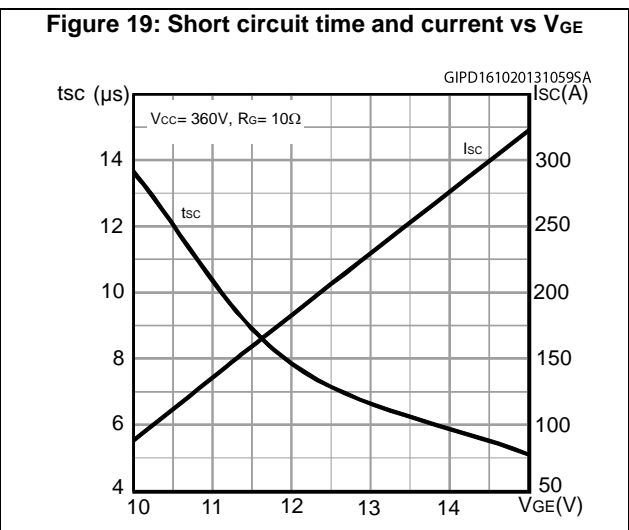
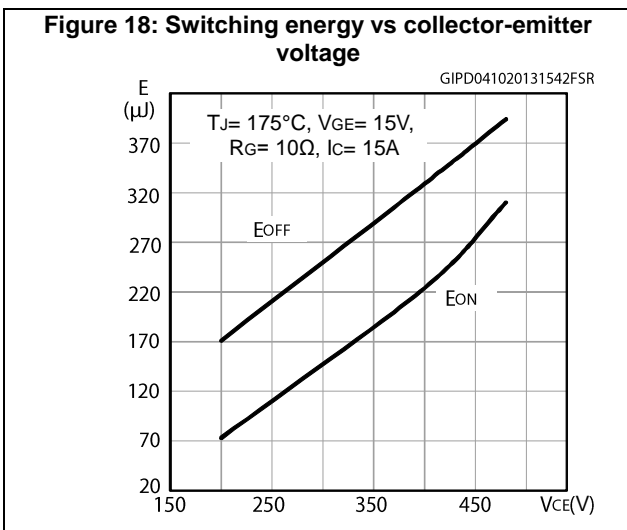
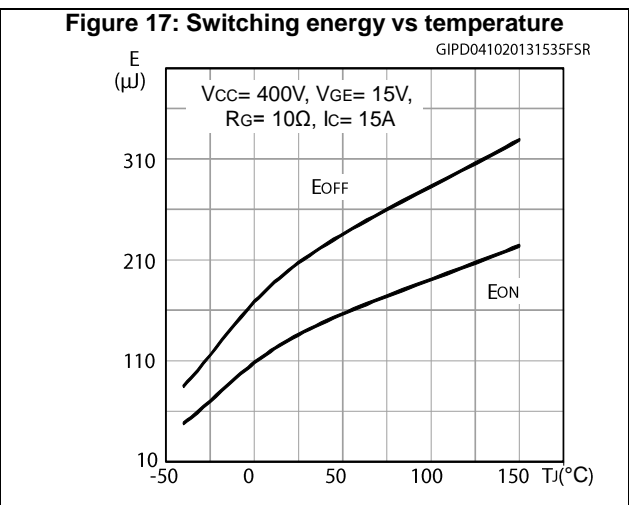
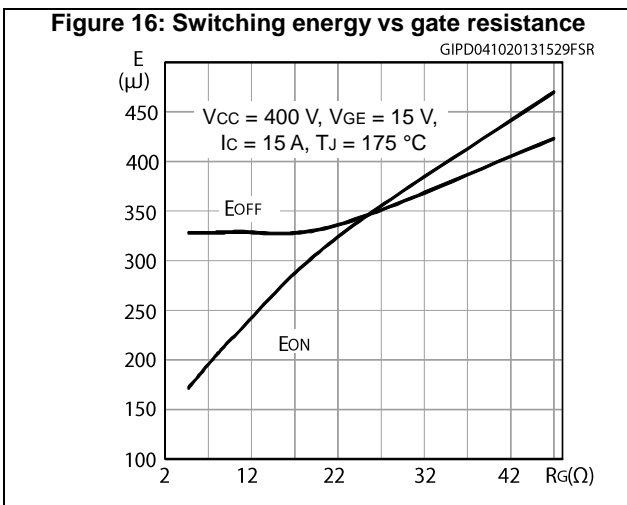
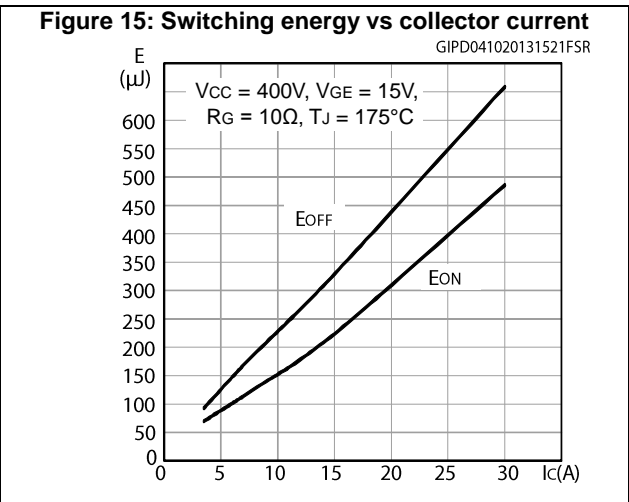
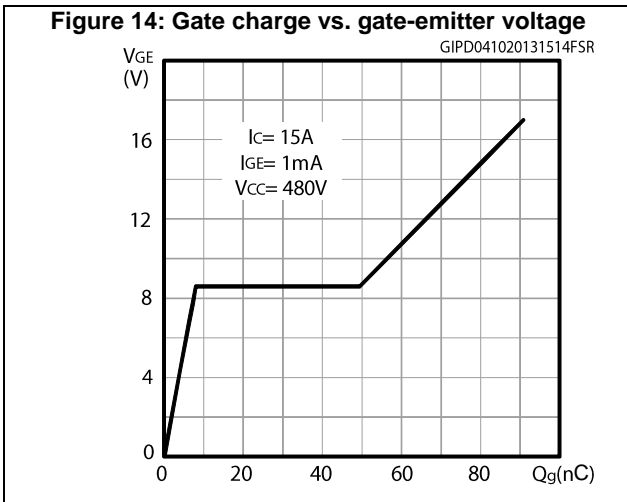
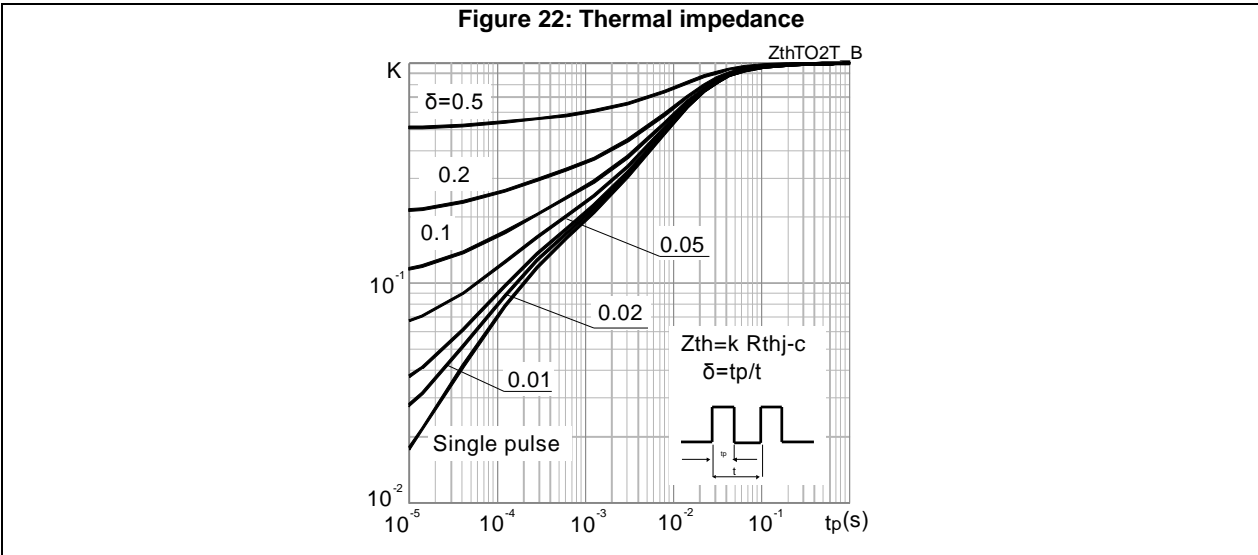
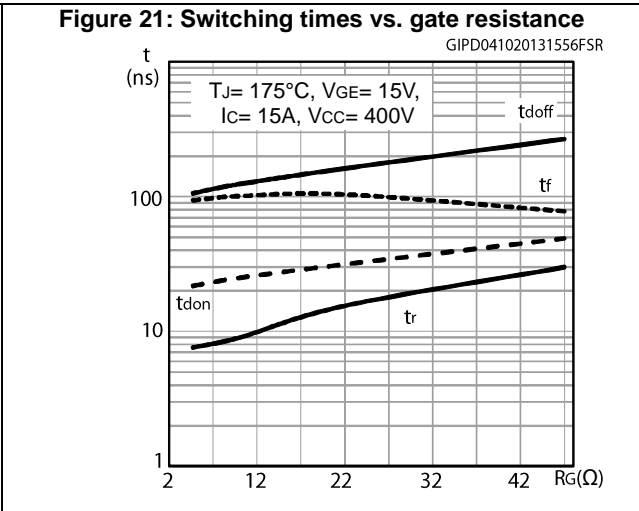
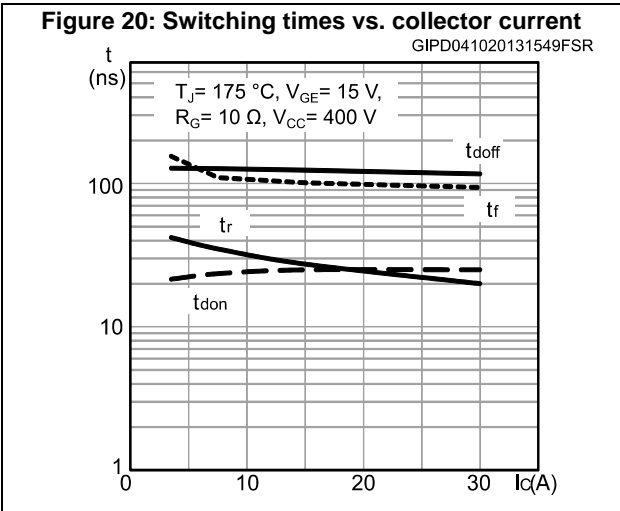


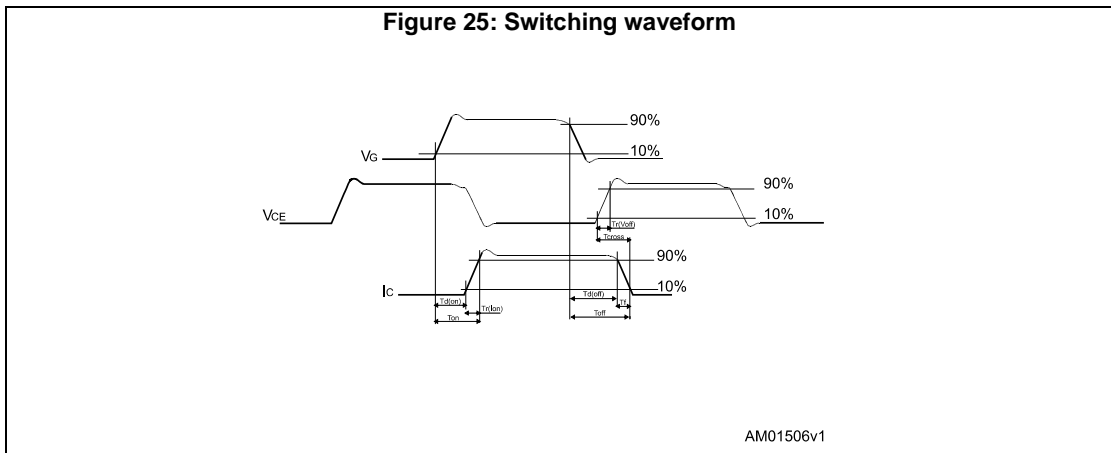
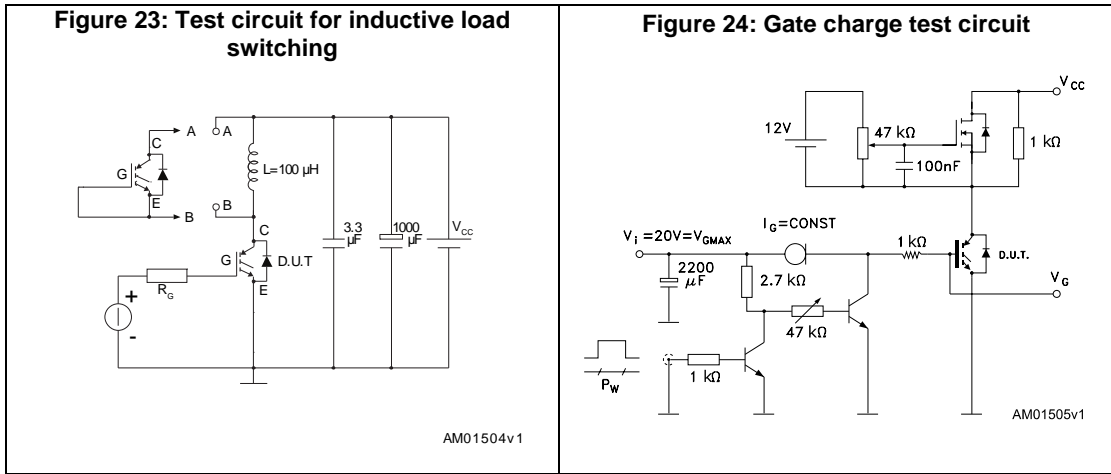
Figure 13: Capacitance variation







3 Test circuits



4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

4.1 TO-3P package information

Figure 26: TO-3P package outline

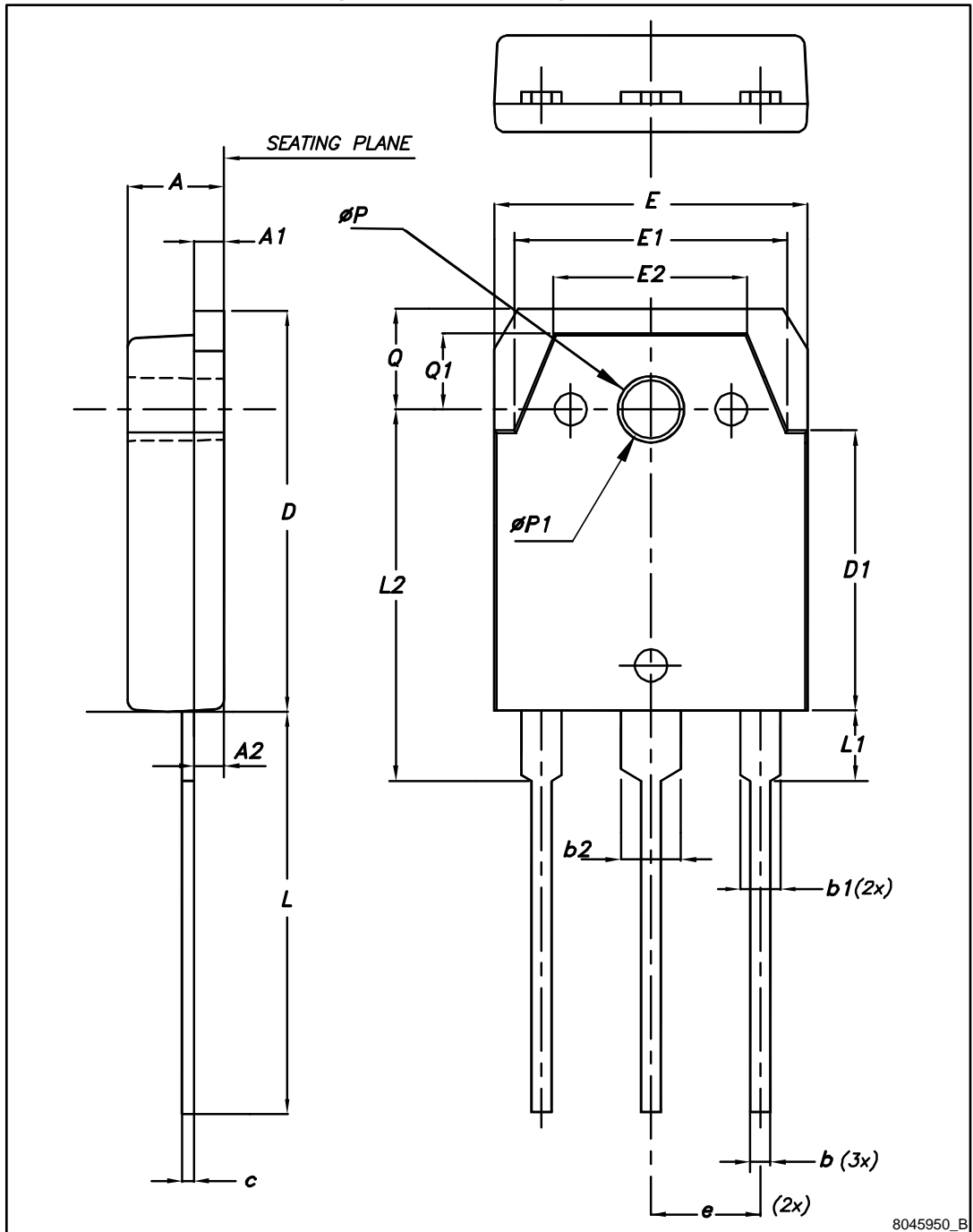


Table 8: TO-3P package mechanical data

| Dim. | mm | | |
|------|-------|-------|-------|
| | Min. | Typ. | Max. |
| A | 4.60 | 4.80 | 5.00 |
| A1 | 1.45 | 1.50 | 1.65 |
| A2 | 1.20 | 1.40 | 1.60 |
| b | 0.80 | 1.00 | 1.20 |
| b1 | 1.80 | 2.00 | 2.20 |
| b2 | 2.80 | 3.00 | 3.20 |
| c | 0.55 | 0.60 | 0.75 |
| D | 19.70 | 19.90 | 20.10 |
| D1 | 13.70 | 13.90 | 14.10 |
| E | 15.40 | 15.60 | 15.80 |
| E1 | 13.40 | 13.60 | 13.80 |
| E2 | 9.40 | 9.60 | 9.90 |
| e | 5.15 | 5.45 | 5.75 |
| L | 19.80 | 20.00 | 20.20 |
| L1 | 3.30 | 3.50 | 3.70 |
| L2 | 18.20 | 18.40 | 18.60 |
| ØP | 3.30 | 3.40 | 3.50 |
| ØP1 | 3.10 | 3.20 | 3.30 |
| Q | 4.80 | 5.00 | 5.20 |
| Q1 | 3.60 | 3.80 | 4 |

5 Revision history

Table 9: Document revision history

| Date | Revision | Changes |
|-------------|----------|---------------|
| 10-Feb-2017 | 1 | First release |

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